

Electronic Acknowledgement Receipt

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Application Number:	10537509
International Application Number:	
Confirmation Number:	4531
Title of Invention:	Method for cutting semiconductor substrate
First Named Inventor/Applicant Name:	Fumitsugu Fukuyo
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)/ Message Digest	Multi Part /.zip	Pages (if appl.)
1		46884_5388_ids.pdf	87353 2049a47b70283f9ba7f93a44095621e3353a17ea4e	yes	3
Multipart Description/PDF files in .zip description					
	Document Description		Start		End
	Information Disclosure Statement Letter		1		2
	Information Disclosure Statement (IDS) Filed (SB/08)		3		3
Warnings:					
Information:					
2	Foreign Reference	46884_5388_JP39184_ref.pdf	1212089 4aff5c614c86d3d900a2f138ea81574bdc9f4d27	no	21
Warnings:					
Information:					
3	NPL Documents	46884_5388_JPOA.pdf	59377 aa74386ee2073d3139c381c303854448915d02a	no	2
Warnings:					
Information:					
4	Fee Worksheet (PTO-06)	fee-info.pdf	30359 4312ba44f68d7f554bdc3a2384779706da04d82e	no	2
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